

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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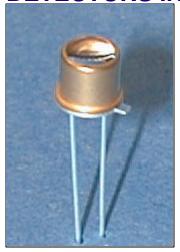


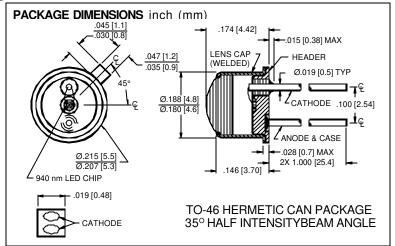




## **PHOTONIC** DETECTORS INC.

### **High-Power & Current GaAs Infrared Emitters** Peak Wavelength, 940 nm, Type PDI-E917





#### **FEATURES**

- Dual cathode
- High current
- Medium emission angle

#### **DESCRIPTION:** The **PDI-E917** infrared emitting **APPLICATIONS**

diode uses dual cathode, high current liquid phase epitaxially grown GaAs. Optimized for high ... power, and high current at 940 nm. Packaged in a

- Photoelectric switches
- Reflective switches

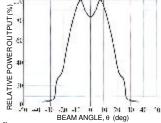
TYPICAL RADIATION PATTERN

• Smoke detectors

TO-46 can with a glass lens cap.

ABSOLUTE MAXIMUM RATING (TA=25°C unless otherwise noted)

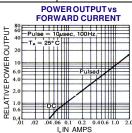
ABOULOTE IMAXIMOM TIATING (TA=25 & difference follows)								
SYMBOL	PARAMETER	MIN	MAX	UNITS				
Pd	Power Dissipation		360	mW				
l <sub>ep</sub>	Continuous Forward Current		180	mA				
l <sub>EP</sub>	Peak Forward Current (100µs pulse,10pps	)	3.0	Α				
V <sub>R</sub>	Reverse voltage		3.0	V				
To & Ts	Storage & Operating Temperature	-65	+125	°C				
TS	Soldering Temperature*		+260	°C				
1/1C inch from acce for O acce may								

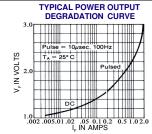


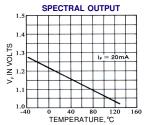
1/16 inch from case for 3 secs max

### ELECTRO-OPTICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Po	Output Power	lf = 100 mA	1.0	5.0		mW
VF	Forward Voltage	I= 100 mA		1.35	1.75	V
<b>I</b> R	Reverse Current	V <sub>R</sub> = -3.0 V			10	mA
λР	Peak Wavelength	lf = 50 mA	925	940	955	nm
Dλ	Spectral Halfwidth	l= 50 mA		50		nm
R₀	Dynamic Resistance	I <sub>E</sub> = 100 mA		0.6		Ohm
tr	Rise Time	l= 100 mA		1.1		μS
<b>t</b> f	Fall Time	l⊧ = 100 mA		1.5		mS







Information in this technical data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice. Optical power and radiant intensity measured using uncapped dimpled TO-46 into integrating sphere.